CTLSH1-40M832D

SURFACE MOUNT DUAL, HIGH CURRENT LOW V_{F} SILICON SCHOTTKY RECTIFIERS



• Device is Halogen Free by design

APPLICATIONS:

- DC/DC Converters
- Reverse Battery Protection
- Battery Powered Portable Equipment

www.centralsemi.com

DESCRIPTION:

The CENTRAL SEMICONDUCTOR CTLSH1-40M832D Dual, Isolated, Low V_F Silicon Schottky rectifiers are designed for applications where small size and operational effciency are the prime requirements. With a maximum power dissipation of 1.65W, and a very small package footprint (approximately equal to the SOT-23), this leadless package design is capable of dissipating up to 4 times the power of similar devices in comparable sized surface mount packages.

MARKING CODE: CFA

FEATURES:

- High Current (I_F=1.0A)
- Low Forward Voltage Drop (V_F=0.55V MAX @ 1.0A)
- · High Thermal Efficiency
- Small TLM 3x2mm case

MAXIMUM RATINGS: (T _A =25°C)	SYMBOL		UNITS
Peak Repetitive Reverse Voltage	V_{RRM}	40	V
Continuous Forward Current	I _F	1.0	Α
Peak Repetitive Forward Current, tp≤1.0ms	I _{FRM}	3.5	Α
Peak Forward Surge Current, tp=8.0ms	I _{FSM}	10	Α
Power Dissipation (Note 1)	P_{D}	1.65	W
Operating and Storage Junction Temperature	T _J , T _{stg}	-65 to +150	°C
Thermal Resistance (Note 1)	ΘΙΔ	75.8	°C/W

ELECTRICAL CHARACTERISTICS: (T_A=25°C unless otherwise noted)

SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
I_{R}	V _R =5.0V			10	μΑ
I_R	V _R =8.0V			20	μΑ
I_R	V _R =15V			50	μΑ
I_R	V _R =40V			0.2	mA
I_R	V _R =40V, T _A =100°C			20	mA
BV_R	I _R =100μA	40			V
V_{F}	I _F =10mA			0.29	V
V_{F}	I _F =100mA			0.36	V
VF	I _F =500mA			0.45	V
V_{F}	I _F =1.0A			0.55	V
СЈ	V _R =4.0V, f=1.0MHz		50		pF

Notes: (1) FR-4 Epoxy PC Board with copper mounting pad area of 54mm²

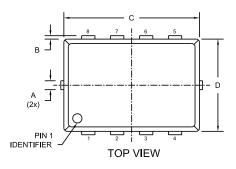
R4 (19-February 2010)

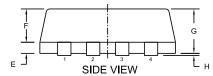
CTLSH1-40M832D

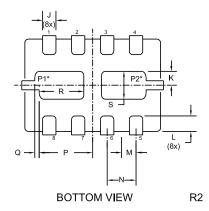
SURFACE MOUNT DUAL, HIGH CURRENT LOW $V_{\mbox{\scriptsize F}}$ SILICON SCHOTTKY RECTIFIERS



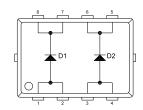
TLM832D CASE - MECHANICAL OUTLINE







- * Note:
- Exposed pad P1 common to pins 7 and 8 $\,$
- Exposed pad P2 common to pins 5 and 6

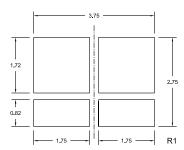


DIMENSIONS							
	INCHES		MILLIM	ETERS			
SYMBOL	MIN	MAX	MIN	MAX			
Α	0.007	0.012	0.170	0.300			
В	-	0.005	-	0.125			
С	0.114	0.122	2.900	3.100			
D	0.075	0.083	1.900	2.100			
Е	0.006	0.010	0.150	0.250			
F	0.026	0.030	0.650	0.750			
G	0.031	0.039	0.800	1.000			
Н	0.000	0.002	0.000	0.050			
J	0.009	0.013	0.240	0.340			
K	0.006	0.014	0.160	0.360			
L	0.008	0.018	0.200	0.450			
М	0.013		0.325				
N	0.026		0.650				
Р	0.040	0.048	1.010	1.210			
Q	0.004		0.100				
R	0.032	0.040	0.820	1.020			
S	0.017	0.025	0.430	0.630			
TI M922D (DEV): D2)							

TLM832D (REV: R2)

SUGGESTED MOUNTING PADS For Maximum Power Dissipation

(Dimensions in mm)



For standard mounting refer to TLM832D Package Details

LEAD CODE:

1) Anode D1 5) Cathode D2 2) Anode D1 6) Cathode D2 3) Anode D2 7) Cathode D1 4) Anode D2 8) Cathode D1

MARKING CODE: CFA

R4 (19-February 2010)

www.centralsemi.com